

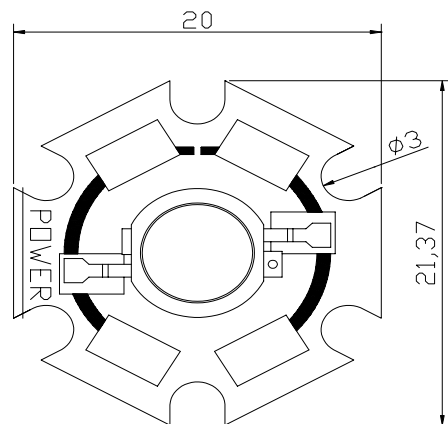
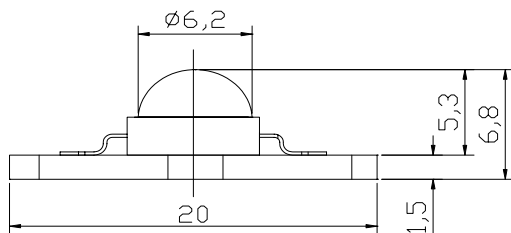
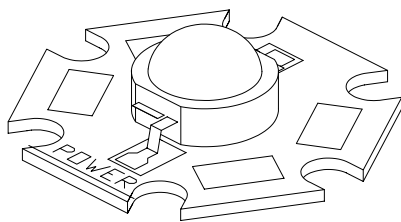


YETDA INDUSTRY LTD

5W HIGH POWER LED (STAR V) B081F-5W

Features	Applications
* Long operating life	* Reading lights (car, bus, aircraft)
* Highest flux	* LCD Backlights/light Guides
* Available in White:2500K-25000K	* Fiber optic alternative/ Decorative Entertainment
* Lambertian radiation pattern	* Mini-accent/Up lighters/Down lighters/ Orientation
* More energy efficient than incandescent and most halogen lamps	* Indoor/Outdoor commercial and Residential Architectural
* Low voltage DC operated	* Cove/Under shelf/Task
* Cool beam, safe to the touch	* Bollards/Security/Garden
* Instant light (less than 100ns)	* Portable (flashlight, bicycle)
* Fully dimmable	* Edge-lit signs (Exit, point of sale)
* No UV	* Automotive Exit (Stop-Tail-Turn,CHMSL, Mirror Side Repeat)
* Superior ESD protection	* Traffic signaling / Beacons / RailCrossing and Wayside
* Eutectic die bonding	
* RoHS compliant	

PACKAGE





Typical Optical/ Electrical Characteristics @TJ=25

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=700mA	6		8	V
Reverse Current	IR	VR=5v			50	uA
50% Power Angle	2θ1/2	IF=700mA		120		deg
Luminous Intensity	φV	IF=700mA	60		80	lm
Recommend Forward Current	IF	--		700		mA
Wavelength	λ d	IF=700mA		470		nm
Thermal Resistance, Junction to Case	RJP	IF=700mA		10		/w

Notes:

1. Tolerance of measurement of forward voltage±0.1V.
2. Tolerance of measurement of peak Wavelength±2.0nm.
3. Tolerance of measurement of luminous intensity±15%.

Absolute Maximum Rating

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	700	mA
Peak Forward Current*	IFP	1200	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	5000	mW
Electrostatic discharge	ESD	±4500	V
Operation Temperature	TOPR	-40~+80	
Storage Temperature	TSTG	-40~+100	
Lead Soldering Temperature*	TSOL	Max. 260 for 3sec Max.	

*IFP Conditions Pulse Width≤10msec duty≤1/10

- * All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.
- * Re-flow, wave peak and soak- stannum soldering etc.is not suitable for this products.
- * Suggest to solder it by professional high power LED soldering machine.
- * Can use invariable-temperature searing-iron with soldering condition:≤260 degree less than 3 seconds.

Typical Optical/Electrical Characteristics Curves



(T_J=25 Unless Otherwise Noted)

Fig 1. Relative Luminous FLux
vs. Forward Current

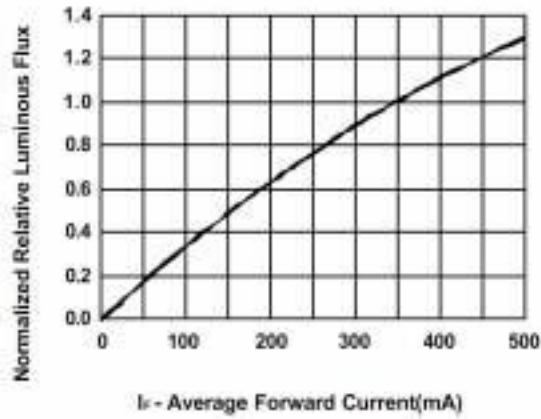


Fig 2. Forward Current
vs. Forward Voltage

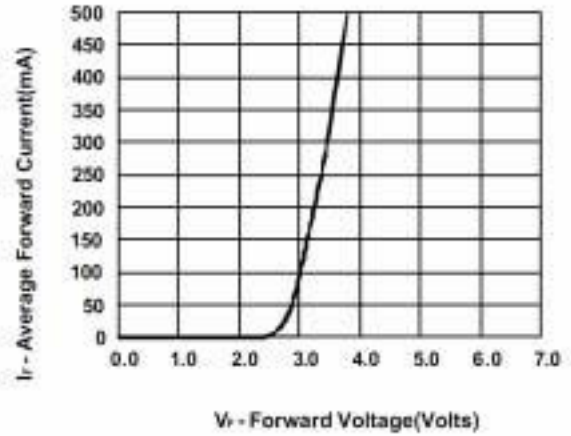


Fig 3. Maximum Forward Current
vs. Ambient Temperature.
Derating based on T_{Jmax}=120°C

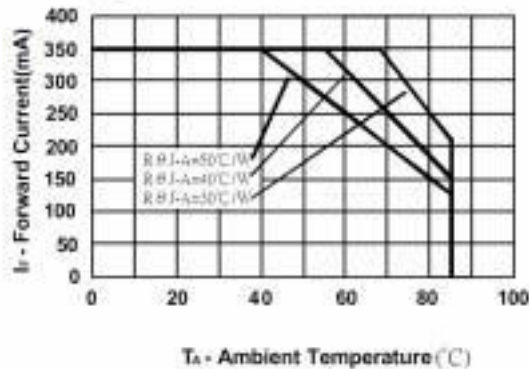


Fig 4. Relative Light Output
vs. Junction Temperature

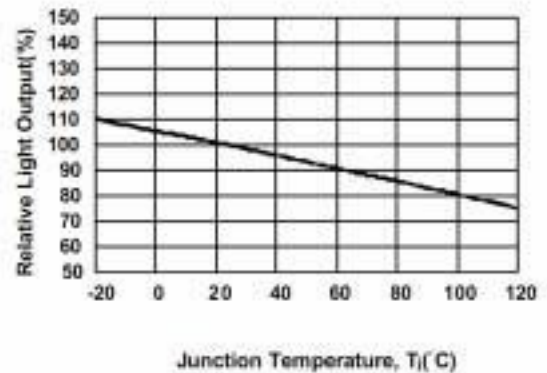


Fig 5. Relative Spectral Power Distribution
vs. Wavelength

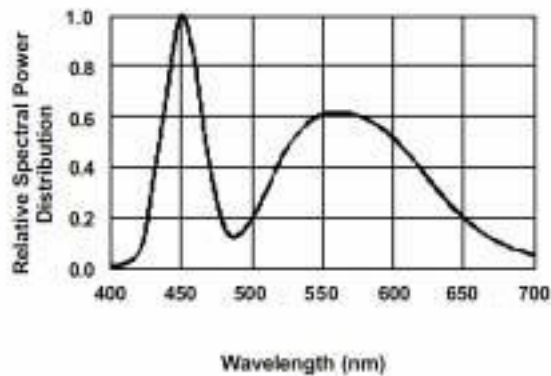
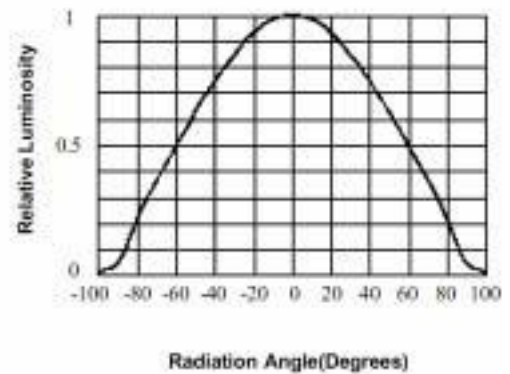
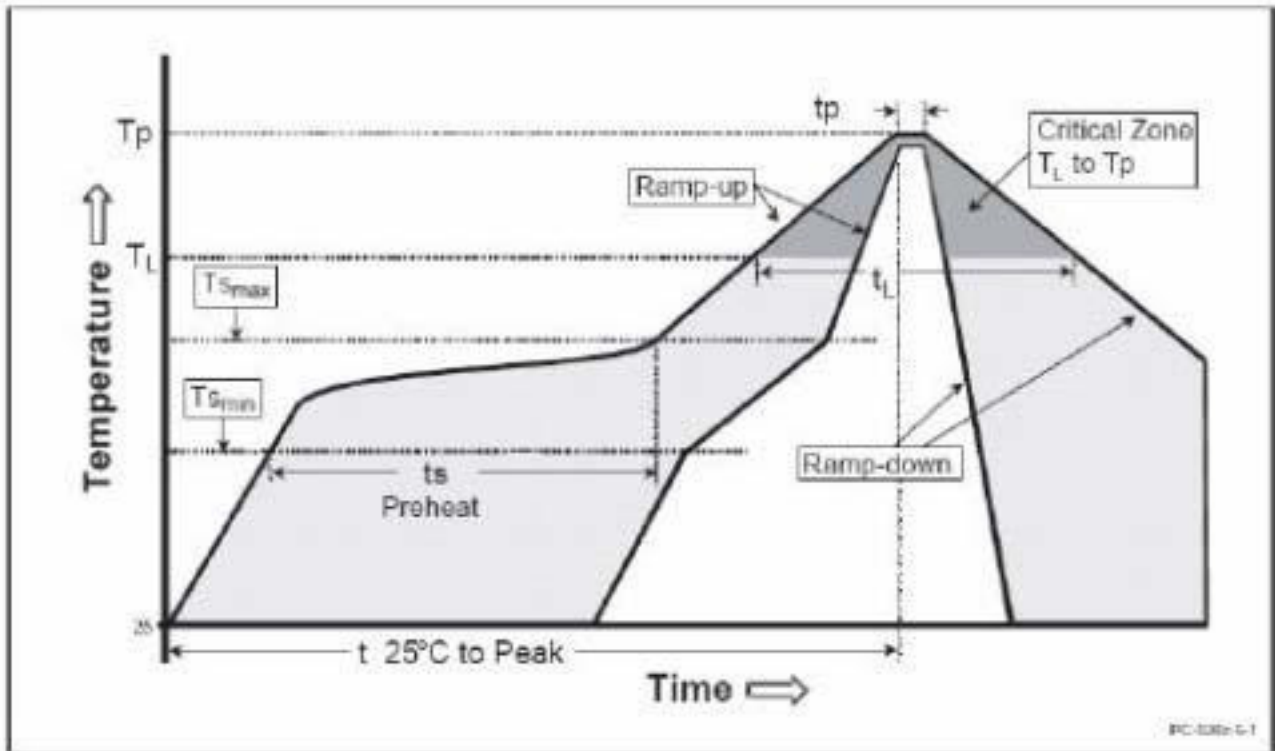


Fig 6. Relative Luminosity
vs. Radiation Angle





Profile Feature	Pb-Free Assembly
Preheat	
– Temperature Min (T _{gmin})	60-180 seconds
– Temperature Max (T _{gmax})	150 °C
– Time (t _{gmin} to t _{gmax})	200 °C
– Temperature (T _L)	
– Time (t _L)	60-150 seconds
Time maintained above:	217 °C
Peak/Classification Temperature (T _p)	260 °C
Time within 5 °C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-Down Rate	6 °C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Notes

1. All temperatures refer to Solder Pad